This user's guide describes the characteristics, operation, and use of the TPS543C20AEVM-054 evaluation module (EVM). The user's guide includes test information, descriptions, and results. A complete schematic diagram, printed-circuit board layouts, and bill of materials are also included in this document. Throughout this user's guide, the abbreviations EVM, TPS543C20AEVM-054, and the term evaluation module are synonymous with the TPS543C20AEVM-054, unless otherwise noted.

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Trademarks

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1 Introduction

The BSR054EVM evaluation module uses the TPS543C20AEVM-054 device. The TPS543C20AEVM-054 is a highly integrated synchronous buck converter that is designed for up to 40-A current output.

1.1 Before You Begin

The following warnings and cautions are noted for the safety of anyone using or working close to the TPS543C20AEVM-054. Observe all safety precautions.

**Warning**
The TPS543C20AEVM-054 circuit module may become hot during operation due to dissipation of heat. Avoid contact with the board. Follow all applicable safety procedures applicable to your laboratory.

**Caution**
Do not leave the EVM powered when unattended.

**WARNING**
The circuit module has signal traces, components, and component leads on the bottom of the board. This may result in exposed voltages, hot surfaces or sharp edges. Do not reach under the board during operation.

**CAUTION**
The circuit module may be damaged by over temperature. To avoid damage, monitor the temperature during evaluation and provide cooling, as needed, for your system environment.

**CAUTION**
Some power supplies can be damaged by application of external voltages. If using more than 1 power supply, check your equipment requirements and use blocking diodes or other isolation techniques, as needed, to prevent damage to your equipment.

**CAUTION**
The communication interface is not isolated on the EVM. Be sure no ground potential exists between the computer and the EVM. Also be aware that the computer is referenced to the Battery- potential of the EVM.
2 Description

The BSR054EVM is designed as a single output DC/DC converter that demonstrates the TPS543C20AEVM-054 in a typical low-voltage application while providing a number of test points to evaluate the performance. It uses a nominal 12-V input bus to produce a regulated 0.9-V output at up to 40-A load current.

2.1 Typical End-User Applications

- Enterprise storage, SSD, NAS
- Wireless and wired communication infrastructure
- Industrial PCs, automation, ATE, PLC, video surveillance
- Enterprise server, switches, routers
- ASIC, SoC, FPGA, DSP core and I/O rails

2.2 EVM Features

- Regulated 0.9-V output up to 40-A, steady-state output current
- Convenient test points for probing critical waveforms

3 EVM Electrical Performance Specifications

Table 1. BSR054EVM Electrical Performance Specifications

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Input Characteristics</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Voltage range</td>
<td>( V_{IN} ) tied to ( VDD )</td>
<td>5</td>
<td>12</td>
<td>16</td>
<td>V</td>
</tr>
<tr>
<td>Maximum input current</td>
<td>( V_{IN} = 12 ) ( V ), ( I_O = 40 ) ( A ), ( V_{OUT} = 0.9 ) ( V ), ( F_{SW} = 500 ) ( kHz )</td>
<td>3.5</td>
<td></td>
<td></td>
<td>A</td>
</tr>
<tr>
<td>No load input current</td>
<td>( V_{IN} = 12 ) ( V ), ( I_O = 0 ) ( A )</td>
<td>50</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td><strong>Output Characteristics</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>( V_{OUT} ) Output voltage</td>
<td>Output current = 0 ( A ) to 40 ( A )</td>
<td>0.9</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>( I_{OUT} ) Output load current</td>
<td>( I_{OUT(min)} ) to ( I_{OUT(max)} )</td>
<td>0</td>
<td>40</td>
<td></td>
<td>A</td>
</tr>
<tr>
<td>Output voltage regulation</td>
<td>Line regulation: input voltage = 5 ( V ) to 16 ( V )</td>
<td>0.5%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Load regulation: output current = 0 ( A ) to ( I_{OUT(max)} )</td>
<td>0.5%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>( V_{OUT} ) Output voltage ripple</td>
<td>( V_{IN} = 12 ) ( V ), ( I_{OUT} = 40 ) ( A )</td>
<td>10</td>
<td></td>
<td></td>
<td>mV_{PP}</td>
</tr>
<tr>
<td>( V_{OUT} ) Output overcurrent</td>
<td></td>
<td>46</td>
<td></td>
<td></td>
<td>A</td>
</tr>
<tr>
<td><strong>Systems Characteristics</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Switching frequency</td>
<td>( F_{SW} )</td>
<td>500</td>
<td></td>
<td></td>
<td>kHz</td>
</tr>
<tr>
<td>Peak efficiency</td>
<td>( V_{IN} = 12 ) ( V ), ( I_O = 17 ) ( A ), ( F_{SW} = 500 ) ( kHz )</td>
<td>90%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Operating temperature</td>
<td>( T_{oper} )</td>
<td>0</td>
<td>85</td>
<td></td>
<td>ºC</td>
</tr>
</tbody>
</table>
Figure 1. BSR054EVM Schematic
5 Test Equipment

**Voltage Source:** The input voltage source \( V_{IN} \) must be a 0-V to 18-V variable DC source capable of supplying at least 10 A\(_{DC}\). Also, the output impedance of the external voltage source must be much less than 100 k\( \Omega \).

**Multimeters:** It is recommended to use two separate multimeters Figure 2. One meter is used to measure \( V_{IN} \) and one to measure \( V_{OUT} \).

**Output Load:** A variable electronic load is recommended for testing Figure 2. It must be capable of 40 A at voltages as low as 0.6 V.

**Oscilloscope:** An oscilloscope is recommended for measuring output noise and ripple. Output ripple must be measured using a tip-and-barrel method or better as shown in Figure 3. The scope must be adjusted to 20-MHz bandwidth, AC coupling at 50 mV/division, and must be set to 1-\( \mu \)s/division.

**Fan:** During prolonged operation at high loads, it may be necessary to provide forced air cooling with a small fan aimed at the EVM. Temperature of the devices on the EVM must be maintained below 105°C.

**Recommended Wire Gauge:** The voltage drop in the load wires must be kept as low as possible in order to keep the working voltage at the load within its operating range. Use the AWG 14 wire (2 wires parallel for \( V_{OUT} \) positive and 2 wires parallel for the \( V_{OUT} \) negative) of no more than 1.98 feet between the EVM and the load. This recommended wire gauge and length should achieve a voltage drop of no more than 0.2 V at the maximum 40-A load.
Figure 2. BSR054EVM Overview

Figure 3. Tip and Barrel Measurement

Metal Ground
Barrel

Probe
Tip
### 7 List of Test Points, Jumpers, and Switch

#### Table 2. Test Point Functions

<table>
<thead>
<tr>
<th>Item</th>
<th>Type</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>TP23</td>
<td>T-H loop</td>
<td>SW</td>
<td>Power supply Switch node</td>
</tr>
<tr>
<td>TP11</td>
<td>T-H loop</td>
<td>CH-A</td>
<td>Measure loop stability</td>
</tr>
<tr>
<td>TP12</td>
<td>T-H loop</td>
<td>CH-B</td>
<td>Measure loop stability</td>
</tr>
<tr>
<td>TP3</td>
<td>T-H loop</td>
<td>LocS+</td>
<td>Sense VOUT + locally across C11. Use for efficiency and ripple measurements</td>
</tr>
<tr>
<td>TP10</td>
<td>T-H loop</td>
<td>LocS-</td>
<td>Sense VOUT– locally across C11. Use for efficiency and ripple measurements</td>
</tr>
<tr>
<td>TP1</td>
<td>T-H loop</td>
<td>PVIN</td>
<td>Sense VIN + across C8</td>
</tr>
<tr>
<td>TP4</td>
<td>T-H loop</td>
<td>PGND</td>
<td>Sense VIN – across C8</td>
</tr>
<tr>
<td>TP6</td>
<td>T-H loop</td>
<td>VDD</td>
<td>Supplies the internal circuitry</td>
</tr>
<tr>
<td>TP9</td>
<td>T-H loop</td>
<td>BP</td>
<td>LDO output</td>
</tr>
<tr>
<td>TP14</td>
<td>T-H loop</td>
<td>PG</td>
<td>Power good</td>
</tr>
<tr>
<td>TP7, TP15, TP16, TP17</td>
<td>T-H loop</td>
<td>PGND</td>
<td>Common GND</td>
</tr>
<tr>
<td>TP19, TP20, TP21, TP22</td>
<td>T-H loop</td>
<td></td>
<td>Not used</td>
</tr>
<tr>
<td>TP18</td>
<td>T-H loop</td>
<td>SYNC</td>
<td>Synchronize with external switching frequency</td>
</tr>
<tr>
<td>JP3</td>
<td>2-pin jumper</td>
<td>EN</td>
<td>Enable or disable TPS543C20AEVM-054 IC</td>
</tr>
</tbody>
</table>
8 Test Procedure

8.1 Line and Load Regulation Measurement Procedure

1. Connect VOUT to J2 and VOUT_GND to J2 Figure 2.
2. Ensure that the electronic load is set to draw 0 A_{DC}.
3. Ensure the jumper provided on the EVM shorts on J3 before V_{IN} is applied.
4. Connect VIN to J1 and VIN_GND to J1 Figure 2.
5. Increase V_{IN} from 0 V to 12 V using the digital multimeter to measure input voltage.
6. Remove the jumper on J3 to enable the controller.
7. Use the other digital multimeter or the oscilloscope to measure output voltage V_{OUT} at TP3 and TP10.

Table 3. List of Test Points for Line and Load Measurements

<table>
<thead>
<tr>
<th>Test Point</th>
<th>Node Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>TP3</td>
<td>LocS+</td>
<td>Sense VOUT + locally across C11. Use for efficiency and ripple measurements</td>
</tr>
<tr>
<td>TP10</td>
<td>LocS-</td>
<td>Sense VOUT - locally across C11. Use for efficiency and ripple measurements</td>
</tr>
<tr>
<td>TP1</td>
<td>PVIN</td>
<td>Sense VIN + across C8</td>
</tr>
<tr>
<td>TP4</td>
<td>PGND</td>
<td>Sense VIN - across C8</td>
</tr>
</tbody>
</table>

8. Vary the load from 0 A_{DC} to maximum rated output 40 A_{DC}. V_{OUT} must remain in regulation as defined in Table 1.

9. Vary V_{IN} from 5 V to 16 V. V_{OUT} must remain in regulation as defined in Table 1.

10. Decrease the load to 0 A.
11. Put the jumper back on JP3 to disable the converter.
12. Decrease V_{IN} to 0 V or turn off the supply.

8.2 Efficiency

To measure the efficiency of the power train on the EVM, it is important to measure the voltages at the correct location. This is necessary because otherwise the measurements will include losses in efficiency that are not related to the power train itself. Losses incurred by the voltage drop in the copper traces and in the input and output connectors are not related to the efficiency of the power train, and they must not be included in efficiency measurements.

Table 4. List of Test Points for Efficiency Measurements

<table>
<thead>
<tr>
<th>Test Point</th>
<th>Node Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>TP3</td>
<td>LocS+</td>
<td>Sense VOUT + locally across C11. Use for efficiency and ripple measurements</td>
</tr>
<tr>
<td>TP10</td>
<td>LocS-</td>
<td>Sense VOUT - locally across C11. Use for efficiency and ripple measurements</td>
</tr>
<tr>
<td>TP1</td>
<td>PVIN</td>
<td>Sense VIN + across C8</td>
</tr>
<tr>
<td>TP4</td>
<td>PGND</td>
<td>Sense VIN - across C8</td>
</tr>
</tbody>
</table>

Input current can be measured at any point in the input wires, and output current can be measured anywhere in the output wires of the output being measured. Using these measurement points result in efficiency measurements that do not include losses due to the connectors and PCB traces.
8.3 Equipment Shutdown
1. Reduce the load current to 0 A.
2. Reduce input voltage to 0 V.
3. Shut down the external fan if in use.
4. Shut down equipment.

9 Performance Data and Typical Characteristic Curves
Figure 4 through Figure 13 present typical performance curves for the BSR054EVM.

9.1 Efficiency

![Graph showing efficiency of 0.9-V output vs load](image-url)

Figure 4. Efficiency of 0.9-V Output vs Load
9.2 Power Loss

Figure 5. Power Loss of 0.9-V Output vs Load
9.3 Load Regulation

Figure 6. Load Regulation of 0.9-V Output

9.4 Transient Response

Figure 7. Transient Response of 0.9-V Output at 12-V\textsubscript{IN}, Transient is 15 A to 25 A to 15 A, the Step is 10 A at 40 A/µs
9.5 Output Ripple

Figure 8. Output Ripple and SW Node of 0.9-V Output at 12-V<sub>IN</sub>, 40-A Output

Figure 9. Output Ripple and SW Node of 0.9-V Output at 12-V<sub>IN</sub>, 0-A Output
9.6  Control On

Figure 10. Start up from Control, 0.9-V Output at 12-V<sub>IN</sub>, 10-mA Output

Figure 11. 0.5-V Pre-bias start up from Control, 0.9-V Output at 12-V<sub>IN</sub>, 20-A Output
9.7 Control On and Off

Figure 12. Output Voltage Start-up and Shutdown, 0.9-V Output at 12-V_{IN}, 0.5-A Output
9.8 Thermal Image

Figure 13. Thermal Image at 0.9-V Output at 12 V\textsubscript{in}, 40-A Output, at 25°C Ambient
Figure 14 through Figure 21 show the design of the BSR054EVM printed-circuit board (PCB). The BSR054EVM has a 2-oz. copper finish for all layers.

Figure 14. BSR054EVM Top Layer Assembly Drawing (Top View)
Figure 15. BSR054EVM Top Solder Mask (Top View)
Figure 16. BSR054EVM Top Layer (Top View)
Figure 17. BSR054EVM Inner Layer 1 (Top View)
Figure 18. BSR054EVM Inner Layer 2 (Top View)
Figure 19. BSR054EVM Inner Layer 3 (Top View)
Figure 20. BSR054EVM Inner Layer 4 (Top View)
Figure 21. BSR054EVM Bottom Layer (Top View)
Figure 22. BSR054EVM Bottom Solder Mask (Top View)
Figure 23. BSR054EVM Bottom Overlay Layer (Top View)
11 List of Materials

The EVM components list, according to the schematic, is shown in Table 5.

Table 5. BSR054EVM List of Materials

<table>
<thead>
<tr>
<th>Designator</th>
<th>Quantity</th>
<th>Value</th>
<th>Description</th>
<th>Package Reference</th>
<th>PartNumber</th>
<th>Manufacturer</th>
<th>Alternate Part Number(1)</th>
<th>Alternate Manufacturer(1)</th>
</tr>
</thead>
<tbody>
<tr>
<td>IPCB</td>
<td>1</td>
<td></td>
<td>Printed Circuit Board</td>
<td></td>
<td>BSR054</td>
<td>Any</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>C1, C2, C3, C5, C7</td>
<td>5</td>
<td>22uF</td>
<td>CAP, CERM, 22 µF, 25 V, +/- 20%, X5R, 1206_190</td>
<td>1206_190</td>
<td>C2616X5R1E226M160AB</td>
<td>TDK</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>C4</td>
<td>1</td>
<td>330uF</td>
<td>CAP, AL, 330 µF, 25 V, +/- 20%, 0.15 ohm, SMD</td>
<td>SMT Radial G</td>
<td>EEE-FC1E331P</td>
<td>Panasonic</td>
<td>865230457008</td>
<td>Wurth Elektronik</td>
</tr>
<tr>
<td>C8</td>
<td>1</td>
<td>0.1uF</td>
<td>CAP, CERM, 0.1 µF, 25 V, +/- 10%, X7R, 0603</td>
<td>0603</td>
<td>GRM188R71E104KA01D</td>
<td>MuRata</td>
<td>885012206071</td>
<td>Wurth Elektronik</td>
</tr>
<tr>
<td>C9, C11, C17</td>
<td>3</td>
<td>100uF</td>
<td>CAP, CERM, 100 µF, 6.3 V, +/- 20%, X5R, 1206</td>
<td>1206</td>
<td>GRM31CR60J107ME39L</td>
<td>MuRata</td>
<td>885012108005</td>
<td>-</td>
</tr>
<tr>
<td>C12</td>
<td>1</td>
<td>0.1uF</td>
<td>CAP, CERM, 0.1 µF, 10 V, +/- 10%, X5R, 0603</td>
<td>0603</td>
<td>C6003X104K8RACTU</td>
<td>Kemet</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>C13, C14</td>
<td>1</td>
<td>330uF</td>
<td>CAP, Aluminum Polymer, 330 µF, 2 V, +/- 20%, 0.003 ohm, 7.3x1.8x4.3mm SMD</td>
<td>12.5x13mm</td>
<td>EEFGX0D331R</td>
<td>Panasonic</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>C20</td>
<td>1</td>
<td>1uF</td>
<td>CAP, CERM, 1 µF, 25 V, +/- 10%, X5R, 0402</td>
<td>0402</td>
<td>GRM155R61E105KA12D</td>
<td>MuRata</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>C21</td>
<td>1</td>
<td>4.7uF</td>
<td>CAP, CERM, 4.7 µF, 16 V, +/- 10%, X5R, 0603</td>
<td>0603</td>
<td>GRM188R61C475KAAJ</td>
<td>MuRata</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>C23</td>
<td>1</td>
<td>0.1uF</td>
<td>CAP, CERM, 0.1 µF, 50 V, +/- 10%, X7R, 0603</td>
<td>0603</td>
<td>06035C104KAT2A</td>
<td>AVX</td>
<td>885012206095</td>
<td>Wurth Elektronik</td>
</tr>
<tr>
<td>C24</td>
<td>1</td>
<td>1000pF</td>
<td>CAP, CERM, 1000 pF, 50 V, +/- 10%, COG/NPO, 0603</td>
<td>0603</td>
<td>06035A102KAT2A</td>
<td>AVX</td>
<td>885012060626</td>
<td>Wurth Elektronik</td>
</tr>
<tr>
<td>C25</td>
<td>1</td>
<td>0.01uF</td>
<td>CAP, CERM, 0.01 µF, 50 V, +/- 5%, X7R, 0402</td>
<td>0402</td>
<td>C4002C103J5RACTU</td>
<td>Kemet</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>H9, H10, H11, H12</td>
<td>4</td>
<td></td>
<td>Bump, Hemisphere, 0.44 X 0.20, Clear Transparent Bump</td>
<td>SJ-5303 (CLEAR)</td>
<td>3M</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td>J1, J2</td>
<td>2</td>
<td>Terminal Block, 5.08 mm, 4x1, Brass, TH</td>
<td>4x1 5.08 mm Terminal Block</td>
<td>ED120/45S</td>
<td>On-Shore Technology</td>
<td>61300211121</td>
<td>Wurth Elektronik</td>
<td></td>
</tr>
<tr>
<td>J3</td>
<td>1</td>
<td>Header, 100mil, 2x1, TH</td>
<td>Header, 2x1, 100mil, TH</td>
<td>800-10-002-10-001000</td>
<td>Mill-Max</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td>L1</td>
<td>1</td>
<td>470nH</td>
<td>Inductor, Shielded Drum Core, Ferrite, 470 nH, 40.5 A, 0.000165 ohm, SMD</td>
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<td>Thermal Transfer Printable Labels, 0.650&quot; W x 0.200&quot; H - 10,000 per roll</td>
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<td>0</td>
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<td>R0805JR-073RL</td>
<td>Yageo America</td>
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(1) Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.
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<th>Designator</th>
<th>Quantity</th>
<th>Value</th>
<th>Description</th>
<th>Package Reference</th>
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<td>Red Miniature Testpoint</td>
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<td>40A FIXED FREQUENCY NON-COMPENSATION STACKABLE SYNCHRONOUS BUCK CONVERTER, RVF0040A (LQFN-CLIP-40)</td>
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STANDARD TERMS FOR EVALUATION MODULES

1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an “EVM” or “EVMs”) to the User (“User”) in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.

1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM (“Software”) shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software.

1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.

2 Limited Warranty and Related Remedies/Disclaimers:

2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.

2.2 TI warrants that the TI EVM will conform to TI’s published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User’s design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User’s claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects within ten (10) business days after the defect has been detected.

2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User’s account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user’s authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.
FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lds/lt_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。

http://www.tij.co.jp/lds/lt_ja/general/eStore/notice_01.page

3.3.2 Notice for Users of EVMs Considered “Radio Frequency Products” in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry’s Rule for Enforcement of Radio Law of Japan.

2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or EVMs.

3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.
【無線電波を送信する製品の開発キットをお使いになる際の注意事項】
開発キットの中には技術基準適合証明を受けていないものがあります。
技術基準適合証明を受けていないものご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

日本テキサス・インストゥルメンツ株式会社
東京都新宿区西新宿6丁目24番1号

3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lssds/ti_ja/general/eStore/notice_02.page

3.4 European Union
3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):
This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 EVM Use Restrictions and Warnings:
4.1 EVMs are not for use in functional safety and/or safety critical evaluations, including but not limited to evaluations of life support applications.
4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
4.3 Safety-Related Warnings and Restrictions:
4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.
6. **Disclaimers:**

6.1 **EXCEPT AS SET FORTH ABOVE,** EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.

6.2 **EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN,** NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSES OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.

7. **USER’S INDEMNITY OBLIGATIONS AND REPRESENTATIONS.** USER WILL DEFEND, INDEMNIFY AND HOLD TI, ITS LICENSEES AND THEIR REPRESENTATIVES HARMLESS FROM AND AGAINST ANY AND ALL CLAIMS, DAMAGES, LOSSES, EXPENSES, COSTS AND LIABILITIES (COLLECTIVELY, "CLAIMS") ARISING OUT OF OR IN CONNECTION WITH ANY HANDLING OR USE OF THE EVM THAT IS NOT IN ACCORDANCE WITH THESE TERMS. THIS OBLIGATION SHALL APPLY WHETHER CLAIMS ARISE UNDER STATUTE, REGULATION, OR THE LAW OF TORT, CONTRACT OR ANY OTHER LEGAL THEORY, AND EVEN IF THE EVM FAILS TO PERFORM AS DESCRIBED OR EXPECTED.

8. **Limitations on Damages and Liability:**

8.1 **General Limitations.** IN NO EVENT SHALL TI BE LIABLE FOR ANY SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL, OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF THESE TERMS OR THE USE OF THE EVMS, REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO, COST OF REMOVAL OR REINSTALLATION, ANCILLARY COSTS TO THE PROCUREMENT OF SUBSTITUTE GOODS OR SERVICES, RETESTING, OUTSIDE COMPUTER TIME, LABOR COSTS, LOSS OF GOODWILL, LOSS OF PROFITS, LOSS OF SAVINGS, LOSS OF USE, LOSS OF DATA, OR BUSINESS INTERRUPTION. NO CLAIM, SUIT OR ACTION SHALL BE BROUGHT AGAINST TI MORE THAN TWELVE (12) MONTHS AFTER THE EVENT THAT GAVE RISE TO THE CAUSE OF ACTION HAS OCCURRED.

8.2 **Specific Limitations.** IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMNITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.

9. **Return Policy.** Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the component(s), excluding any postage or packaging costs.

10. **Governing Law:** These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.
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